

SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS

PRODUCT SPECIFICATION 規格書

CUSTOMER: DATE:

(客戶): 志盛翔 (日期): 2017-10-12

CATEGORY (品名) : ALUMINUM ELECTROLYTIC CAPACITORS

DESCRIPTION (型号) : HP 250V820μF(φ30x40)

VERSION (版本) : 01

Customer P/N :

SUPPLIER :

SUPPLIE	ER
PREPARED (拟定)	CHECKED (审核)
李婷	刘渭清

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APPROVAL (批准)	SIGNATURE (签名)									

ELECTROLYTIC CAPACITOR SPECIFICATION HP SERIES

		SPECIFICAT			ALTERNATION HISTORY RECORDS						
Rev.	Date	Mark	Page	Contents	Purpose	Drafter	Approver				
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Table 1 Product Dimensions and Characteristics

W-TYPE

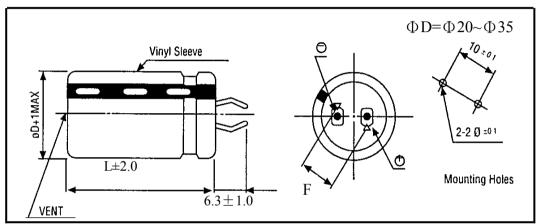


Table 1

No	SAMXON Part No.	WV (Vd	Cap. (μF)	Cap. tolerance	Temp. range(°C)	tanδ (120Hz, 20℃)	Leakage Current (µA,5min)	Max Ripple Current at 105°C 120Hz (A rms)	Load lifetim e (Hrs)	Dimen (m	nsion m) F	Sleev
2	EHP827M2EP40SW**P	250	820	-20%~+20%	-25~105	0.15	1358	2.30	2000	30X40	10±1.0	PET

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4.15 Vent test

Substances')"

4.16 Maximum permissible (ripple current)

Attachment: Application Guidelines

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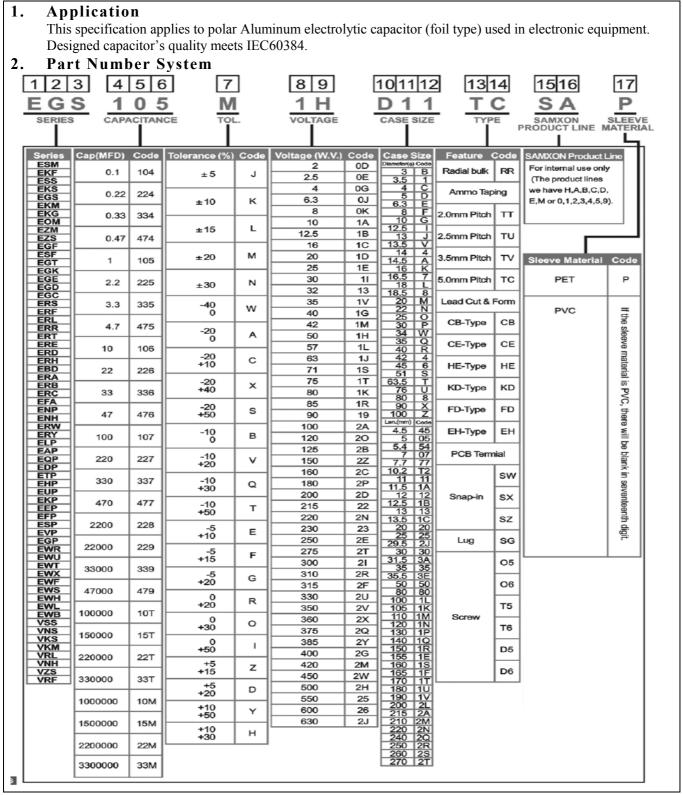
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5. List of "Environment-related Substances to be Controlled ('Controlled

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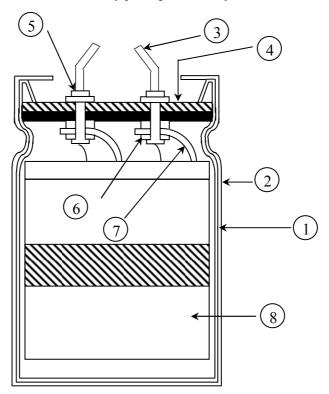
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3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



No	Component	Material
1	Case	Aluminum case
2	Sleeve	PVC/PET
3	Terminal	Solder coated copper clad steel
4	Seal	Rubber-laminated bakelite
5	Rivet	Aluminum
6	Washer	Aluminum
7	Tab	Aluminum
8	Element	Aluminum foil & Electrolyte paper

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is

as follows:

Ambient temperature :15°C to 35°C Relative humidity : 45% to 85% Air Pressure : 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:

Ambient temperature : $20^{\circ}\text{C} \pm 2^{\circ}\text{C}$ Relative humidity : 60% to 70%Air Pressure : 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2

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Table 2												
	ITEM	PERFORMANCE										
	Rated voltage (WV)	WV (V .DC) SV (V .DC)	10	16	25 32	35 44	50	63 79			100 125	160
4.1		WV (V.DC)	180	200	220	250	315	350	400	420	450	500
	Surge voltage (SV)	SV (V.DC)	225	250	270	300	365	400	450	470	500	550
4.2	Nominal capacitance (Tolerance)	Condition> Measuring Frequency : 120Hz±12Hz Measuring Voltage : Not more than 0.5Vrms Measuring Temperature : 20±2°C Criteria> Shall be within the specified capacitance tolerance										
4.3	Leakage current	Condition> Connecting the capacitor with a protective resistor (1k Ω ± 10 Ω) in series for 5 minutes, and then, measure Leakage Current. Criteria> Refer to table 1										
4.4	tan δ	Refer to table 1 <condition> See 4.2, Norm Capacitance, for measuring frequency, voltage and temperature. <criteria> Refer to table 1</criteria></condition>										

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				pplied to the lead wire terminal in the axia y for 30s
4.5	Terminal strength			open or short circuit and there shall be no amage.
		<condition< td=""><td>n></td><td></td></condition<>	n>	
		STEP	Testing Temperature(°C)	Time
		1	20±2	Time to reach thermal equilibrium
		2	-40(-25)±3	Time to reach thermal equilibrium
		3	20±2	Time to reach thermal equilibrium
		4	105±2	Time to reach thermal equilibrium
		5	20 ± 2	Time to reach thermal equilibrium
4.6	Temperature characteristics	of its of tan 8 s. The leavalue. b. In step The leavalue. c. At-40°C following Working Z-25°	5, $\tan \delta$ shall be within the liakage current shall not more (-25°C), impedance (Z) ratio	m 4.4 Il not more than 8 times of its specified imit of Item 4.4 than the specified value shall not exceed the value of the

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4.7	Load life test	Condition> According to IEC60384-4No.4.13 methods, The capacitor is stored at a temperature of 105°C ±2 with DC bias voltage plus the rated ripple current for 2000 +48/0 hours. (The sum of DC and ripple peak voltage shall not exceed the rated working voltage) Then the product should be tested after16 hours recovering time at atmospheric conditions. The result should meet the following table: Criteria> The characteristic shall meet the following requirements. Leakage current Value in 4.3 shall be satisfied Capacitance Change Within ±20% of initial value. tan δ Not more than 200% of the specified value. Appearance There shall be no leakage of electrolyte
4.8	Shelf life test	Condition> The capacitors are then stored with no voltage applied at a temperature of 105±2°C for 1000+48/0 hours. Following this period the capacitors shall be removed from the test chamber and be allowed to stabilized at room temperature for 4~8 hours. Next they shall be connected to a series limiting resistor(1k±100Ω) with D.C. rated voltage applied for 30min. After which the capacitors shall be discharged, and then, tested the characteristics. Criteria> The characteristic shall meet the following requirements. Leakage current Value in 4.3 shall be satisfied Capacitance Change Within ±15% of initial value . tan δ Not more than 150% of the specified value. Appearance There shall be no leakage of electrolyte Remark: If the capacitors are stored more than 1 year, the leakage current may increase. Please apply voltage through about 1 k Ω resistor, if necessary.

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4.9	Surge test	$ \begin{array}{llllllllllllllllllllllllllllllllllll$
4.10	Vibration	This test simulates over voltage at abnormal situation, and not be hypothesizing that over voltage is always applied. *Condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range: 10Hz ~ 55Hz Peak to peak amplitude: 1.5mm Sweep rate: 10Hz ~ 55Hz ~ 10Hz in about 1 minute *Criteria> After the test, the following items shall be tested: No mechanical damage in terminal. No leakage of electrolyte or swelling of the case. The markings shall be legible. Inner: No intermittent contact, open or short circuit. No damage of tab terminals or electrodes. Mounting method: The capacitor must be fixed in place with a bracket. Space < 1 mm

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4.11	Solderability test	Condition> The capacitor shall be tested Soldering temperature Dipping depth Dipping speed Dipping time Criteria> Coating quality	d under the following conditions: : 245±3°C : 2mm : 25±2.5mm/s : 3±0.5s A minimum of 95% of the surface being immersed
		260 ± 5 °C for 10 ± 1 seconds the body of capacitor .	shall be immersed into solder bath at s or $400 \pm 10^{\circ}$ C for 3^{+1}_{-0} seconds to $1.5 \sim 2.0$ mm from the left under the normal temperature and normal core measurement.
		Leakage current	Not more than the specified value.
		Capacitance Change	Within $\pm 10\%$ of initial value .
	Resistance to	tan δ	Not more than the specified value.
4.12	solder heat test	Appearance	There shall be no leakage of electrolyte

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		oven, the condition acc Ten (1)+20°C (2)Rated low tempera (3)Rated high tempera (1) to (3)=1 cycle, total	mperature ture(-40°C) (-25°C) ature (+105°C)	
		(1)+20°C (2)Rated low tempera (3)Rated high tempera	ture(-40°C) (-25°C) ature (+105°C)	≤ 3 Minutes 30 ± 2 Minutes
		(2)Rated low tempera (3)Rated high tempera	ature (+105°C)	30±2 Minutes
		(3)Rated high tempera	ature (+105°C)	
				30 ± 2 Minutes
		(1) to (3)=1 cycle, tota	al 5 cycle	
4 13 ter	C	<criteria></criteria>		
		The characteristic shall		
	test	Leakage current	Not more than the s	•
		tan δ	Not more than the s	_
		Appearance	There shall be no le	eakage of electrolyte
	H	Condition> Iumidity Test: According to IEC60384- be exposed for 500±8 h	_	
		_	_	he following requirement.
	<	Criteria>		
		Leakage current	Not more than the spe	cified value.
1	ı ı	Canagitanaa Changa	Within $\pm 20\%$ of init	ial valua
4.14	Damp	Capacitance Change	vvitilli <u>+</u> 2070 Of fillt	lai value.
4.14	Damp heat	tan δ	Not more than 120% of	

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4.15	Vent test	Condition> The following test only ap D.C. test The capacitor is connected a current selected from T Capacitor is connected from T Capacitor is conn	d with its pol	arity reverse		power source.	Then
		<criteria> The vent shall operate wi of pieces of the capacitor</criteria>		ous condition	ns such as	flames or dispe	ersion
		Condition> The maximum permissible at 120Hz and can be appl Table-1 The combined value of D. rated voltage and shall no Frequency Multipliers:	ied at maximoder and C voltage and	um operatin I the peak A	g temperat	ture	ed the
	Maximum permissible (ripple	Coefficient Freq. (Hz) Voltage (V)	60	120	1k	10~50k	
4.16	current)	10~100V	0.90	1.00	1.15	1.25	
		160~250V	0.80	1.00	1.25	1.47	
		315~500V	0.80	1.00	1.30	1.47	
	current)	160~250V	0.80	1.00	1.25	1.47	

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5. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances					
	Cadmium and cadmium compounds					
Heavy metals	Lead and lead compounds					
	Mercury and mercury compounds					
	Hexavalent chromium compounds					
	Polychlorinated biphenyls (PCB)					
Chloinated	Polychlorinated naphthalenes (PCN)					
organic	Polychlorinated terphenyls (PCT)					
compounds	Short-chain chlorinated paraffins(SCCP)					
	Other chlorinated organic compounds					
D : 1	Polybrominated biphenyls (PBB)					
Brominated .	Polybrominated diphenylethers(PBDE) (including					
organic	decabromodiphenyl ether[DecaBDE])					
compounds	Other brominated organic compounds					
Tributyltin comp	ounds(TBT)					
Triphenyltin com	pounds(TPT)					
Asbestos						
Specific azo com	pounds					
Formaldehyde						
Polyvinyl chlorid	e (PVC) and PVC blevds					
Beryllium oxide						
Beryllium coppe	er					
Specific phthalate	es (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)					
Hydrofluorocarbo	on (HFC), Perfluorocarbon (PFC)					
Perfluorooctane s	sulfonates (PFOS)					
Specific Benzotri	azole					

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Attachment: Application Guidelines

1.Circuit Design

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at 20 °C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
 - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while tan δ increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy

See the file: Life calculation of aluminum electrolytic capacitor

1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

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(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements.

Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

1.4 Using Two or More Capacitors in Series or Parallel

(1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

(2) Capacitors Connected in Series

Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.

1.5 Capacitor Mounting Considerations

(1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board.

When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2) Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3) Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

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(4) Clearance for Case Mounted Pressure Relief vents

Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.

φ6.3~ φ16mm:2mm minimum, φ18~ φ35mm:3mm minimum, φ40mm or greater:5mm minimum.

(5) Clearance for Seal Mounted Pressure Relief Vents

A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.

(6) Wiring Near the Pressure Relief Vent

Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.

(7) Circuit Board patterns Under the Capacitor

Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.

(8) Screw Terminal Capacitor Mounting

Do not orient the capacitor with the screw terminal side of the capacitor facing downwards.

Tighten the terminal and mounting bracket screws within the torque range specified in the specification.

1.6 Electrical Isolation of the Capacitor

Completely isolate the capacitor as follows.

- (1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths
- (3) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.
- 1.7 The Product characteristic should take the sample as the standard.

1.8 Capacitor Sleeve

The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor.

The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.

CAUTION!

Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use.

- (1) Provide protection circuits and protection devices to allow safe failure modes.
- (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

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2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about $1 \text{k} \Omega$.
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately $1k\Omega$.
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.

2.2 Capacitor Insertion

- * (1) Verify the correct capacitance and rated voltage of the capacitor.
- * (2) Verify the correct polarity of the capacitor before inserting.
- * (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
 - (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 °C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

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2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- * (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried.
 - The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- * (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
 - Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- . Alkali solvents : could attack and dissolve the aluminum case.
- . Petroleum based solvents: deterioration of the rubber seal could result.
- . Xylene : deterioration of the rubber seal could result.
- . Acetone : removal of the ink markings on the vinyl sleeve could result.
- * (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- * (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

3.1 Environmental Conditions

Capacitors should not be stored or used in the following environments.

- * (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- * (2) Direct contact with water, salt water, or oil.
- * (3) High humidity conditions where water could condense on the capacitor.

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- * (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- * (5) Exposure to ozone, radiation, or ultraviolet rays.
- * (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100° C temperatures.

If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water.

If electrolyte or gas is ingested by month, gargle with water.

If electrolyte contacts the skin, wash with soap and water.

5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a $1000 \,\Omega$, current limiting resistor for a time period of 30 minutes .

5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

- * Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.
- * Dispose of as solid waste.

NOTE: Local laws may have specific disposal requirements, which must be followed.

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